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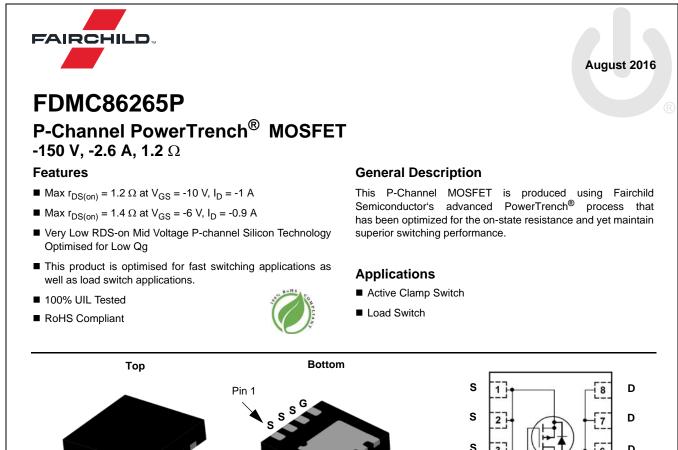


ON Semiconductor®

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MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Param	Ratings	Units			
V _{DS}	Drain to Source Voltage			-150	V	
V _{GS}	Gate to Source Voltage			±25	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	-2.6	A	
	-Continuous	T _C = 100 °C	(Note 5)	-1.65		
D	-Continuous	T _A = 25 °C	(Note 1a)	-1		
	-Pulsed		(Note 4)	-9		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	6	mJ	
	Power Dissipation	T _C = 25 °C		16	14/	
P _D	Power Dissipation	(Note 1a)	2.3	W		
T _J , T _{STG}	Operating and Storage Junction Tempera	ature Range	-	-55 to + 150	°C	

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Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	7.5	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 53	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86265P	FDMC86265P	Power 33	13 "	12 mm	3000 units

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D

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Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Chara	octeristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-150		1	V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		-125		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -120 V, V _{GS} = 0 V			-1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \ \mu A$	-2	-3.2	-4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = -250 µA, referenced to 25 °C		5		mV/°C	
-		V _{GS} = -10 V, I _D = -1 A		0.86	1.2		
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = -6 \text{ V}, \text{ I}_{D} = -0.9 \text{ A}$		0.95	1.4	Ω	
		V _{GS} = -10 V, I _D = -1 A,T _J = 125 °C		1.53	2.2	1	
9 _{FS}	Forward Transconductance	$V_{DS} = -10 \text{ V}, \ I_{D} = -1 \text{ A}$		1.9		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			158	210	pF	
C _{oss}	Output Capacitance	──V _{DS} = -75 V, V _{GS} = 0 V, f = 1 MHz		16	25	pF	
C _{rss}	Reverse Transfer Capacitance			0.7	5	pF	
R _g	Gate Resistance		0.1	3	7.5	Ω	
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time			5.8	12	ns	
t _r	Rise Time	V _{DD} = -75 V, I _D = -1 A,		2.2	10	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = -10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		8	16	ns	
t _f	Fall Time			6.4	13	ns	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V$ to -10 V $V_{DD} = -75 V$,		2.8	4	nC	
Q _{gs}	Total Gate Charge	$I_D = -1 A$		0.8		nC	
Q _{gd}	Gate to Drain "Miller" Charge			0.7		nC	

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Q _{rr}		

NOTES:

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1. R_{0,1A} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,1C} is guaranteed by design while R_{0CA} is determined by the user's board design.

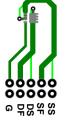
 $I_{F} = -1 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$

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Reverse Recovery Time

Reverse Recovery Charge

a) 53 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 125 °C/W when mounted on a minimum pad of 2 oz copper

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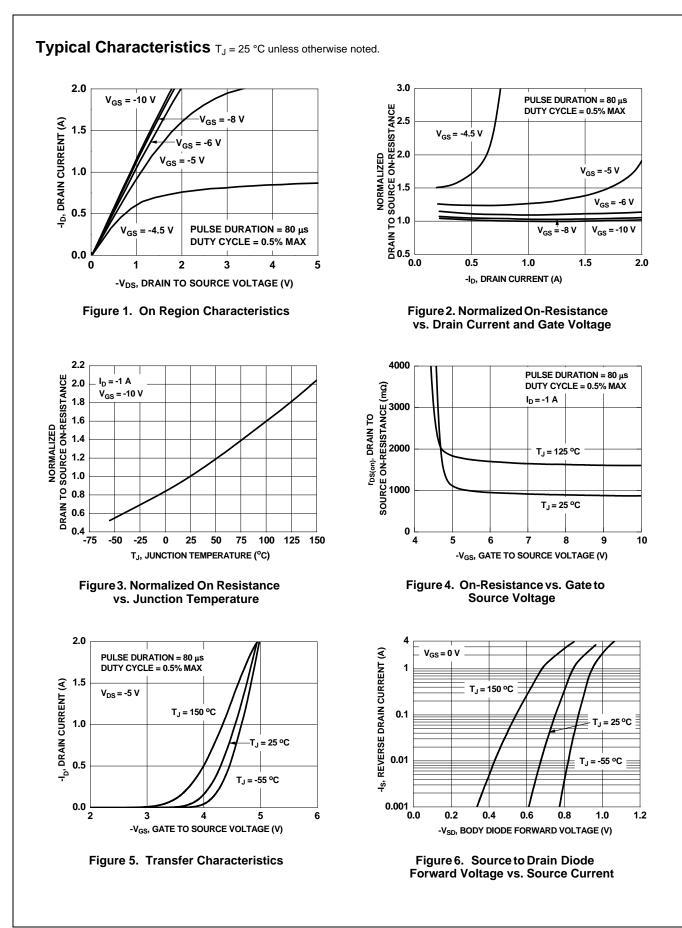
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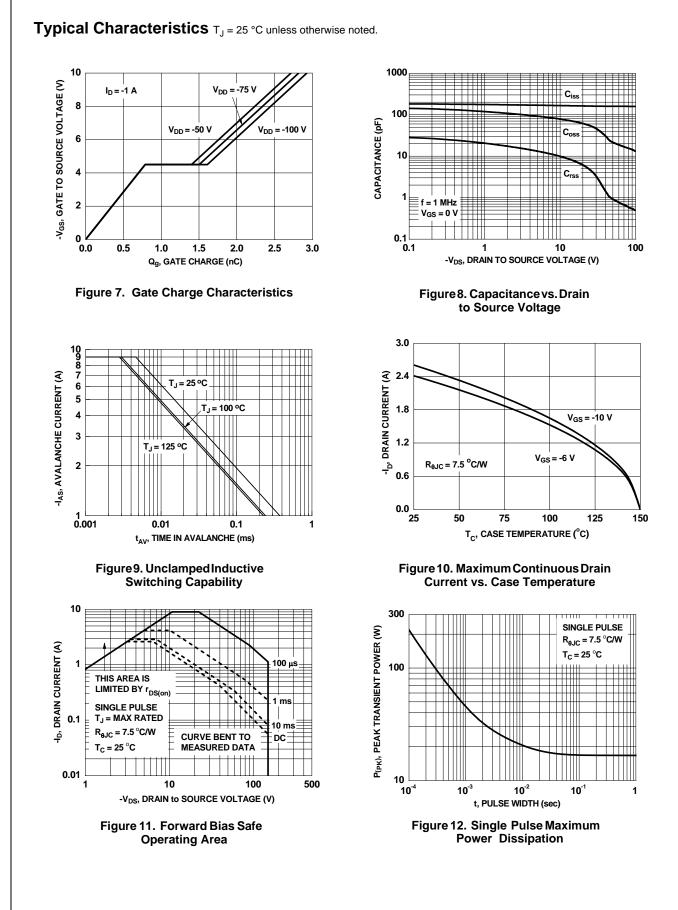
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nC

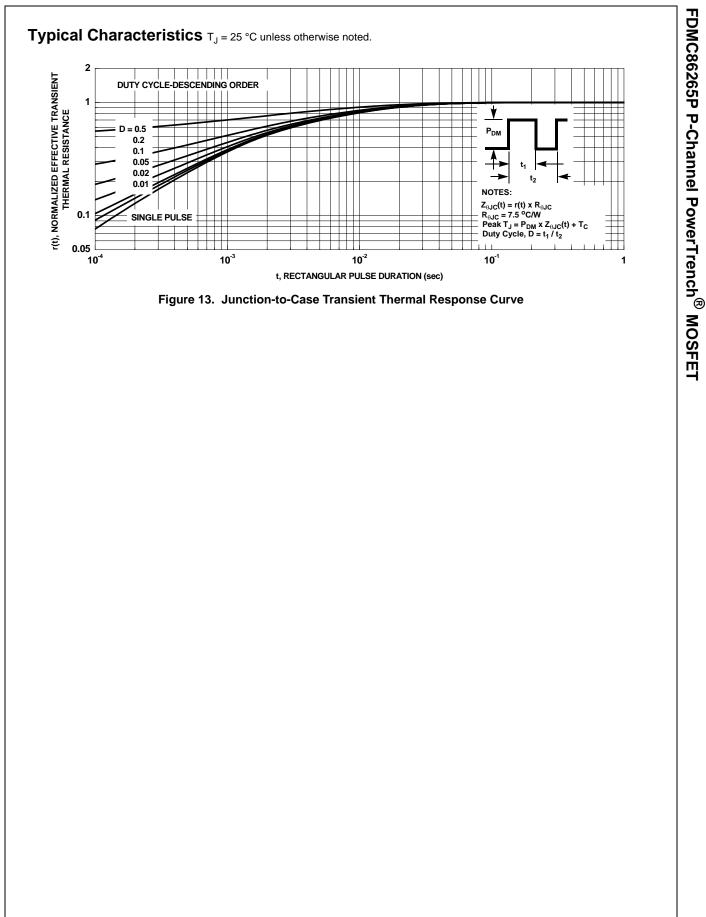
Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
Starting T_J = 25 °C; P-ch: L =3 mH, I_{AS} = -2 A, V_{DD} = -150 V, V_{GS} = -10 V. 100% test at L = 0.1 mH, I_{AS} = -9 A.
Pulsed Id please refer to Fig 11 and Fig 24 SOA graph for more details.
Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

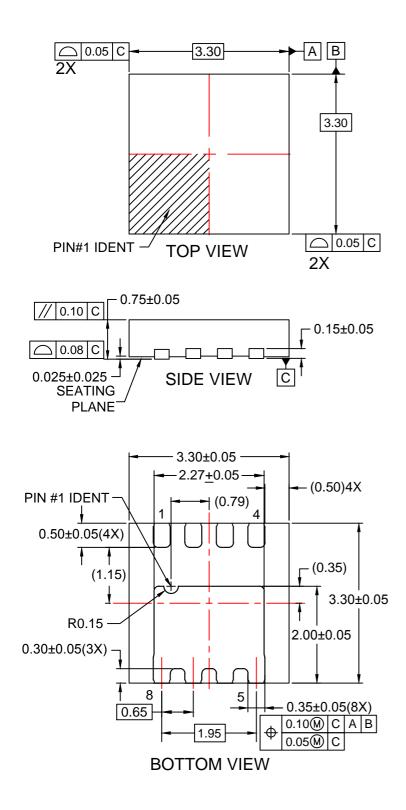


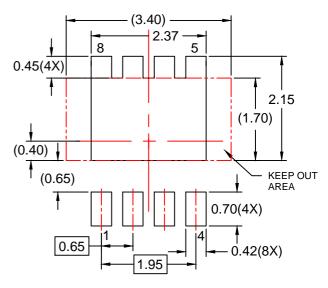




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RECOMMENDED LAND PATTERN

NOTES:

- A. DOES NOT CONFORM TO JEDEC REGISTRATION MO-229
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP08Srev3.



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